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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Craig M. Hill	12/04/2008
Andrew T. Pomerene	12/04/2008
Timothy J. Conway	12/04/2008
Vu A. Vu	12/04/2008
Daniel N. Carothers	01/07/2009

RECEIVING PARTY DATA

Name:	BAE SYSTEMS Information And Electronic Systems Integration Inc.	
Street Address:	65 Spit Brook Road	
City:	Nashua	
State/Country:	NEW HAMPSHIRE	
Postal Code:	03061	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12328853

CORRESPONDENCE DATA

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Phone: 6036686560

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Correspondent Name: Neil F. Maloney

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Address Line 2: 55 South Commercial Street

Address Line 4: Manchester, NEW HAMPSHIRE 03101

ATTORNEY DOCKET NUMBER: BAEP-1022

NAME OF SUBMITTER: Neil F. Maloney

PATENT

REEL: 022116 FRAME: 0816

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Total Attachments: 4 source=Assignment_fully executed#page1.tif source=Assignment_fully executed#page2.tif source=Assignment_fully executed#page3.tif source=Assignment_fully executed#page4.tif

> PATENT REEL: 022116 FRAME: 0817

Case No. BAEP-1022

ASSIGNMENT

For value received, I/We, the undersigned (each) have agreed and hereby agree to assign to BAE SYSTEMS Information And Electronic Systems Integration Inc. (hereinafter referred to as BAE), a Delaware corporation, having a place of business at Nashua, New Hampshire, in furtherance of my/our obligations to BAE, and do hereby assign and transfer to BAE, its successors, and assigns the entire right, title and interest, including the right of priority, in, and to and under an application for Letters Patent of the United States entitled:

MULTI-THICKNESS SEMICONDUCTOR WITH FULLY DEPLETED DEVICES AND PHOTONIC INTEGRATION

Filing date: _____ Application Number: _____

and executed on even date herewith the invention(s) and improvement(s) set forth therein, and any and all
continuations, continuations-in-part (CIPs), divisionals, and renewals of and substitutes for said application for
said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto including
the right of priority under the International Convention which may be granted thereon or therefore; and any
reissues, or reexaminations, or extensions of said Letters Patent.

I/We additionally authorize BAE to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by BAE, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made:

And I/we hereby covenant that I/we have a full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent to BAE, its successors, assigns, nominces or legal representatives, and I/we agree to communicate to BAE, or to its nominee, all known facts respecting said invention(s) or improvement(s) said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, CIPs, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid BAE, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvements(s) in any and all countries;

And I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to BAE, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this Assignment.

I/we further authorize and direct BAE attorneys to insert the application number and filing date of said application now identified by the case number and title set forth above as soon as the same shall have been known to them by the United States Patent and Trademark Office.

12/04/2008 THU 15:23**PA(TE/NXT**NO 5845] ☑ 004

REEL: 022116 FRAME: 0818

Date Assignment Signed:	12/4/08	Craig M. Hill
Date Witness Signed:	12/4/08	[Witness signature] Wesley Banhard [Witness Printed Name]
Date Assignment Signed:	12/4/08	Andrew T. Pomerene
Date Witness Signed:	2/4/58	[Witness signature] Wordy Denteroff
Date Assignment Signed:		[Witness Printed Name] Daniel N. Carothers
Date Witness Signed:		[Witness signature]
Date Assignment Signed:	12/4/08	[Witness Printed Name]
Date Witness Signed:	12/4/08	Margart Strange Myrgaret Strange
Date Assignment Signed:	<u>)2/0408</u> _	Myrage Strange Witness Printed Name Vu A, Vu
Datc Witness Signed:	12/04/8	[Witness signature] Wesley Dechardt [Witness Printed Name]

REEL: 022116 FRAME: 0819

ASSIGNMENT

For value received, I/We, the undersigned (each) have agreed and hereby agree to assign to **BAE SYSTEMS Information And Electronic Systems Integration Inc.** (hereinafter referred to as BAE), a Delaware corporation, having a place of business at Nashua, New Hampshire, in furtherance of my/our obligations to BAE, and do hereby assign and transfer to BAE, its successors, and assigns the entire right, title and interest, including the right of priority, in, and to and under an application for Letters Patent of the United States entitled:

MULTI-THICKNESS SEMICONDUCTOR WITH FULLY DEPLETED DEVICES AND PHOTONIC INTEGRATION

Application Number:

Filing date:_____

and executed on even date herewith the invention(s) and improvement(s) set forth therein, and any and all
continuations, continuations-in-part (CIPs), divisionals, and renewals of and substitutes for said application for
said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto including
the right of priority under the International Convention which may be granted thereon or therefore; and any
reissues or reexaminations or extensions of said Letters Patent

I/We additionally authorize BAE to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by BAE, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

And I/we hereby covenant that I/we have a full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent to BAE, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to BAE, or to its nominee, all known facts respecting said invention(s) or improvement(s) said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, CIPs, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid BAE, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvements(s) in any and all countries;

And I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to BAE, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this Assignment.

I/we further authorize and direct BAE attorneys to insert the application number and filing date of said application now identified by the case number and title set forth above as soon as the same shall have been known to them by the United States Patent and Trademark Office.

PATENT REEL: 022116 FRAME: 0820

Date Assignment Signed:		Craig M. Hill
Date Witness Signed:		[Witness signature]
		[Witness Printed Name]
Date Assignment Signed:		Andrew T. Pomerene
Date Witness Signed:		[Witness signature]
	, / /	[Witness Printed Name]
Date Assignment Signed:	197/09	Daniel N. Carothers
Date Witness Signed:	1/7/09	[Witness signature]
Date Assignment Signed:		[Witness Printed Name]
		Timothy J. Conway
Date Witness Signed:		[Witness signature]
		[Witness Printed Name]
Date Assignment Signed:		Vu A. Vu
Date Witness Signed:		[Witness signature]
		[Witness Printed Name]

PATENT REEL: 022116 FRAME: 0821